571-203-2790

February 27, 2004

ATTORNEY DOCKET NO. 04329.3253 CUSTOMER NO. 22,852



**Mail Stop Patent Application** 

**Commissioner for Patents** P.O. Box 1450 **Alexandria, VA 22313-1450** 

> New U.S. Patent Application Title: SEMICONDUCTOR WAFER DIVIDING METHOD AND **APPARATUS** Inventors and Addresses:

Shinya TAKYU Kitakatsushika-gun, Japan

Ninao SATO Mitaka-shi, Japan

Sir:

We enclose the following papers for filing in the United States Patent and Trademark Office in connection with the above patent application.

- 1. Application- 27 pages, including 3 independent claims and 20 claims total.
- Drawings- 5 sheets of drawings (total) containing 17 figures (Figures 4A, 4B, 6A, 2. 6B, 7A, 7B, 8 and 9 are photographs).
- Certified copy of Japanese Patent Application No. 2003-054688, filed February 3. 28, 2003.
- 4. The filing fee is calculated as follows:

Basic Application Filing Fee					\$770	\$	\$770.00
	Number of Claims		Basic	Extra Claims			
Total Claims	20	-	20		x \$18		
Independent Claims	3	-	3		x \$86		•
☐ Presentation of Multiple Dep. Claim(s) +\$29							
Subtotal						\$	770.00
Reduction by 1/2 if small entity						-	
TOTAL APPLICATION FILING FEE						\$	770.00

## 5. A check for \$770.00 is enclosed.

This application is being filed under the provisions of 37 C.F.R. § 1.53(f). Applicants await notification from the Patent and Trademark Office of the time set for filing the Declaration.

Applicants claim the right to priority based on Japanese Patent Application No. 2003-054688, filed February 28, 2003.

Please address all correspondence with respect to this application to:

Finnegan, Henderson, Farabow, Garrett & Dunner, L.L.P. 1300 I Street, N.W. Washington, D.C. 20005-3315

Please accord this application an application number and filing date.

The Commissioner is hereby authorized to charge any additional filing fees due and any other fees due under 37 C.F.R. § 1.16 or §1.17 during the pendency of this

application to our Deposit Account No. 06-0916.

Respectfully submitted,

FINNEGAN, HENDERSON, FARABOW, GARRETT DUNNER, L.L.P.

By:

Richard V. Burgujian

Reg. No. 31,744

RVB/FPD/dvg Enclosures

ERNEST F. CHAPMAN Reg. No. 25,961